



IEEE 802.3 DTE Power via MDI Detection and Signature Protocol

Richard Glaser

John Jetzt

Dieter Knollman

Robert Leonowich

Donald Stewart

Detection and Signature Protocol Overview



- At the Source:
 - PROBE (low voltage and high resistance) for power-request signature from DTE.
 - APPLY full voltage (low resistance) after signature is detected.
 - REMOVE voltage when current becomes too high or too low.
- At the Load:
 - PRESENT power-request signature (high-resistance) while in off condition.
 - ACCEPT power at load resistance when full voltage is offered.
 - MAINTAIN appropriate current

The Probe will reject:



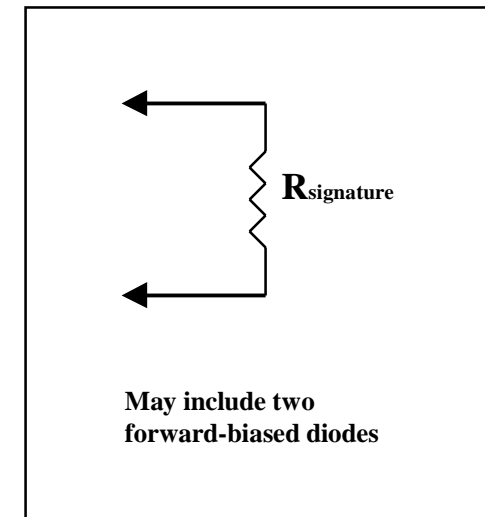
- Open circuit
- Short circuit
- Bob Smith termination
- Another probe or source (opposite polarity)
- Another probe or source (same polarity)
- Appliances with an input impedance low enough to have a damaging amount of power applied

Protocol at DTE



- Present Signature to Loop in OFF State
- Polarity Insensitivity (recommended)
- Provide Galvanic Isolation to Ground
- In ON State:
 - Limit $I_{\text{inrush}} < I_{\text{max}}$
 - Maintain $I_{\text{min}} < I < I_{\text{max}}$

Thevenin Equivalent (OFF State)



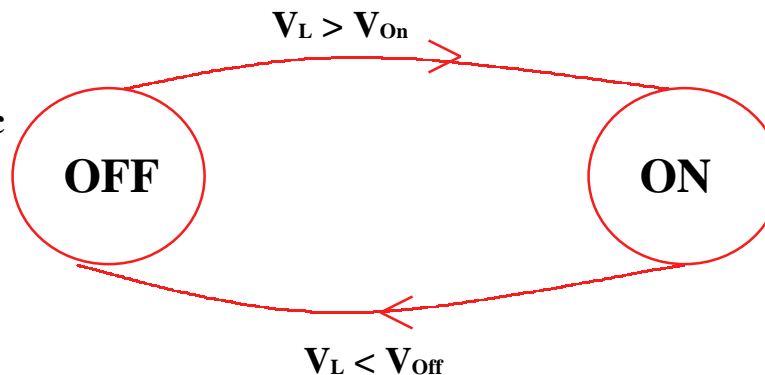
Suggested Values

V_{On} = Turn On Voltage = 35Vdc

V_{Off} = Turn Off Voltage = 30Vdc

V_L = Voltage across load

$R_{\text{signature}}$ = 25K ohms +/-2%

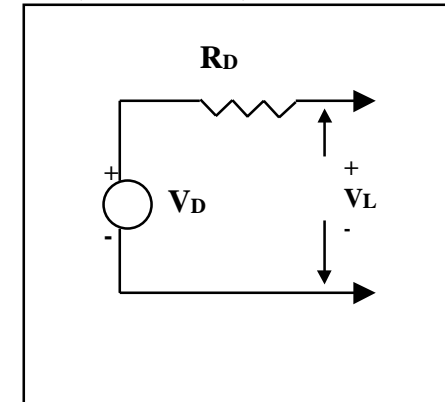


Protocol at Source



- **Pass** when $V_S < V_L < V_O$
(I.e., within signature voltage characteristic)
- **Reject** when
 - $V_L < V_S$: Short, Bob Smith, another Probe or foreign voltage (aiding).
 - $V_L > V_O$: Open, another Probe or foreign voltage (opposing).
- **Turn OFF** when $I > I_{max}$ or $I < I_{min}$.

**Thevenin Equivalent
(Probe State)**



Suggested Values

$I_{max} = 450\text{ma} \pm 50\text{mA}$

$I_{min} = 1\text{-}10\text{ma}$

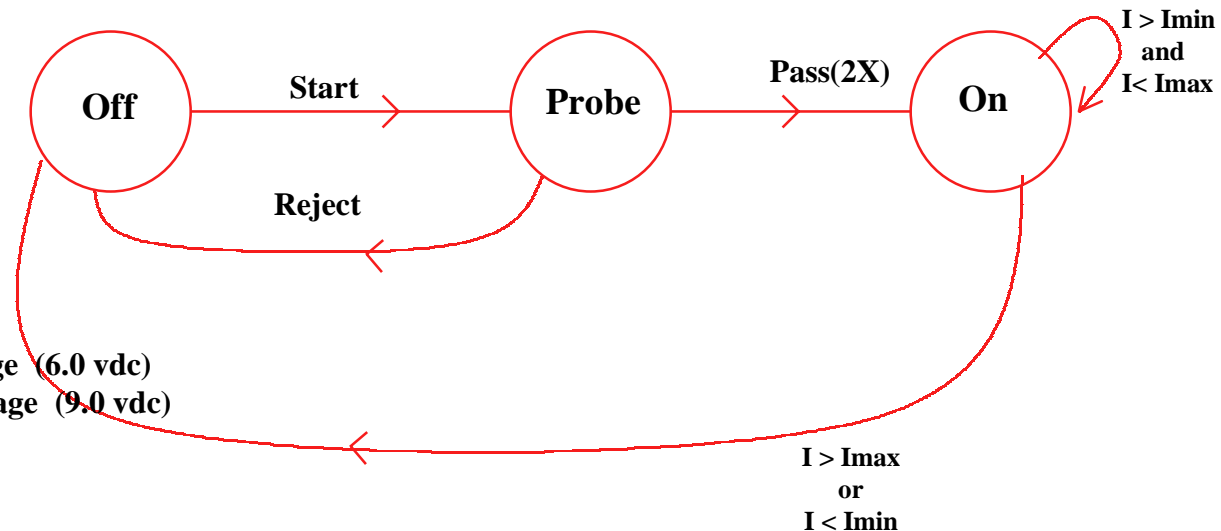
$V_D = 24.5\text{Vdc} \pm 3.5\text{V}$

$R_D = 75\text{K ohms} \pm 2\%$

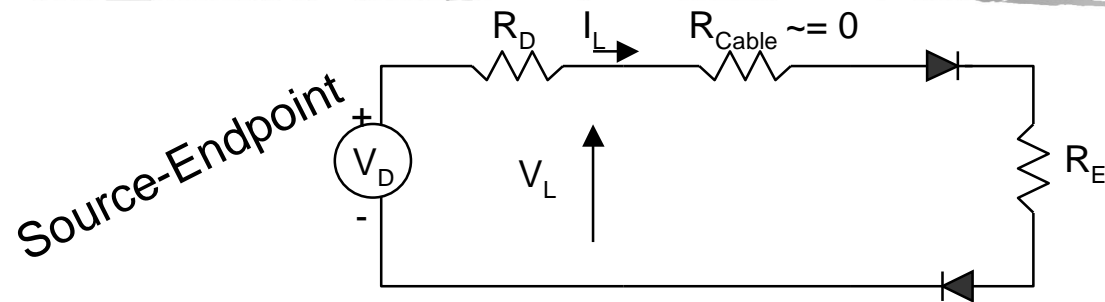
V_L = Voltage across load

V_S = Lowest signature voltage (6.0 vdc)

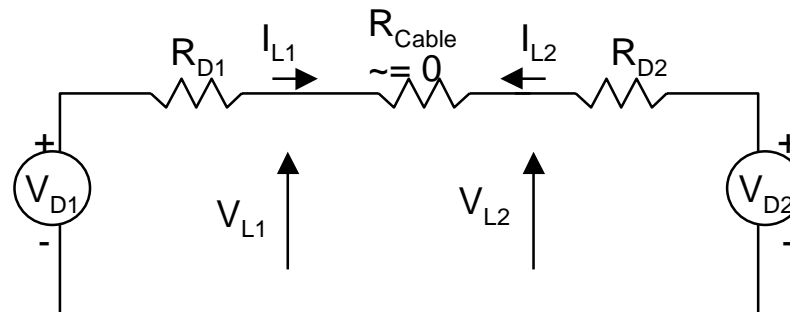
V_O = Highest signature voltage (9.0 vdc)



Schematic Connections



Two Sources,
Opposed

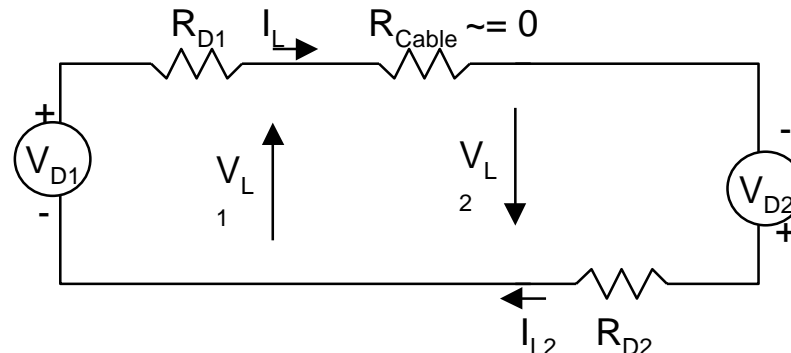


$$V_{L1} \approx V_{L2}$$

$$I_{L1} = -I_{L2}$$

For un-powered state , $V_{D2} = 0$

Two Sources,
Aiding

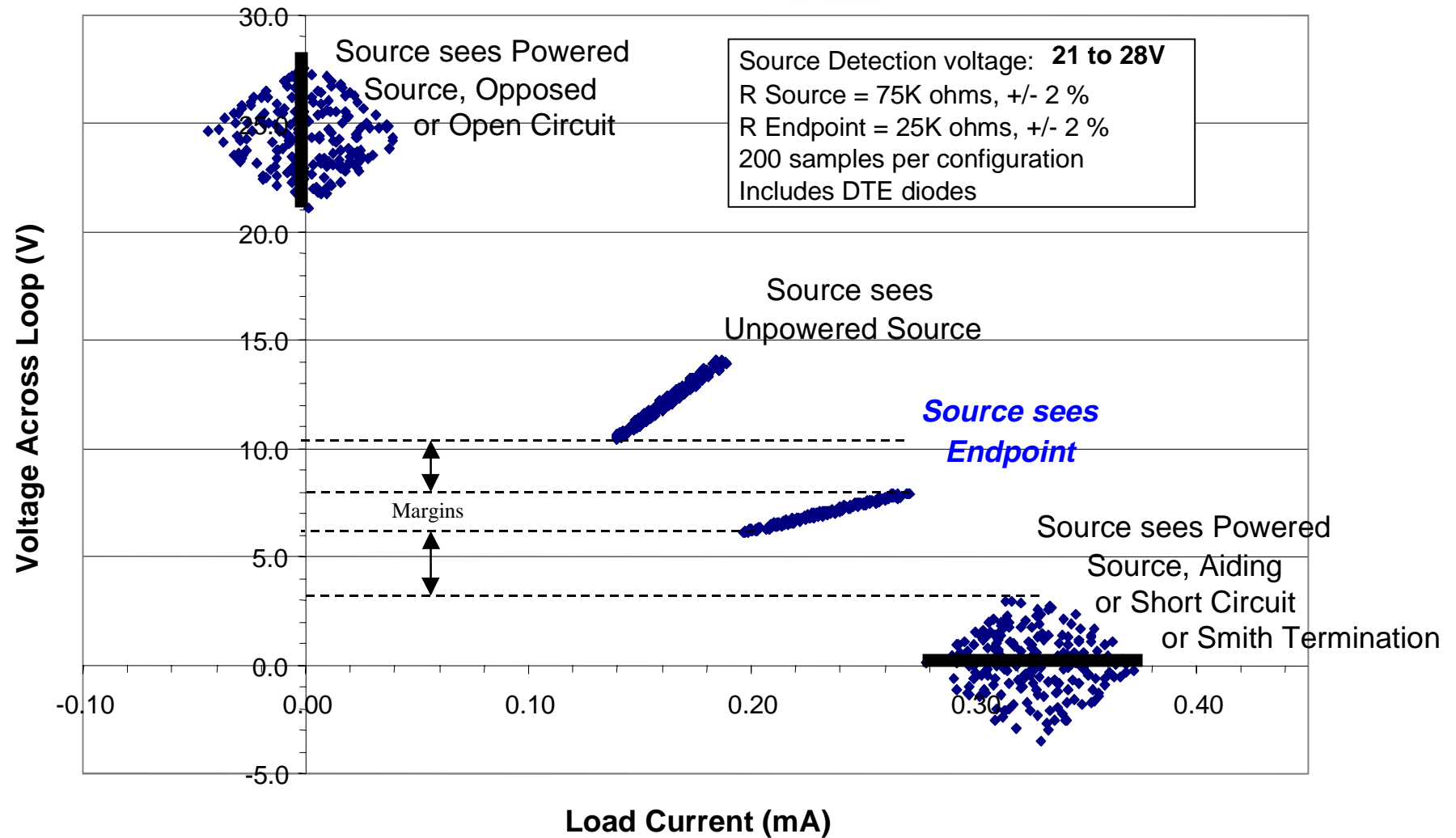


$$V_{L1} \approx -V_{L2}$$

$$I_{L1} = I_{L2}$$

For un-powered state , $V_{D2} = 0$

Signature Margins



Conformance Test



DTE Conformance Test:

- Verify $R_{out}=25K\pm 2\%$ for $10V < V_L < 30V$
- Verify $10mA < I_{ON} < 350mA$ for $35V < V_L < 54V$
- Verify $I_{rush} < I_{MAX}$
- Verify Emission < FCC

Source Conformance Test:

- Verify for a test load $0 < R_{LOAD} < 24K$, $I_{out} < 1mA$, $V_L < 30V$ and for $26K < R_{LOAD} < \text{Infinity}$, $V_L < 30V$
- Verify $48V \pm 6V$ link maintained for $10mA < I_{OUT} < 400mA$ after a 25K resistor signature is presented.